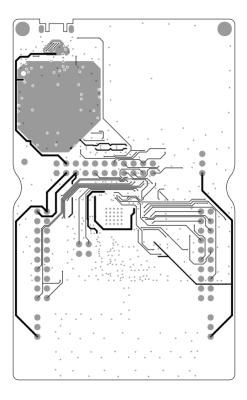
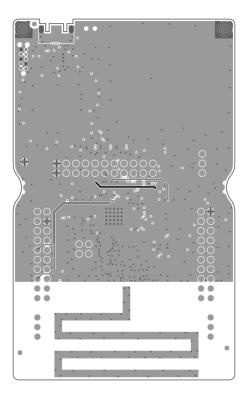
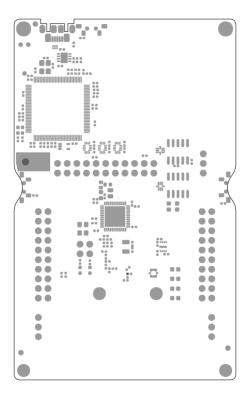


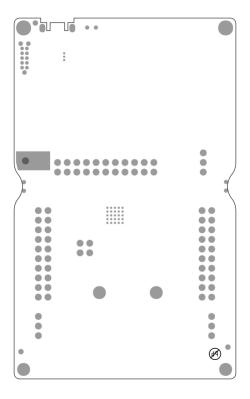
ART FILM - Layer2

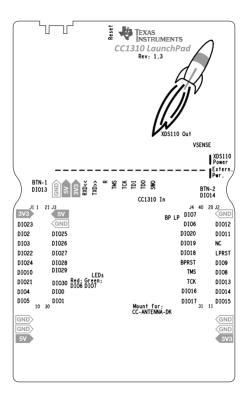


ART FILM - Layer3



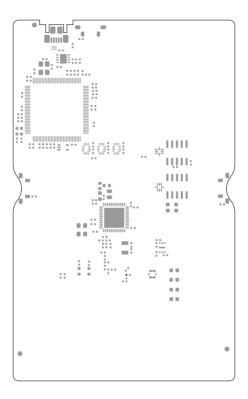


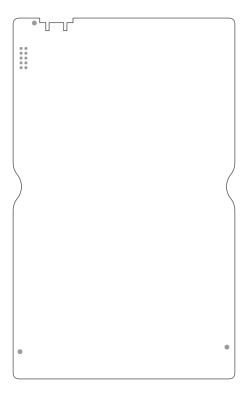






ART FILM - silk_bottom





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